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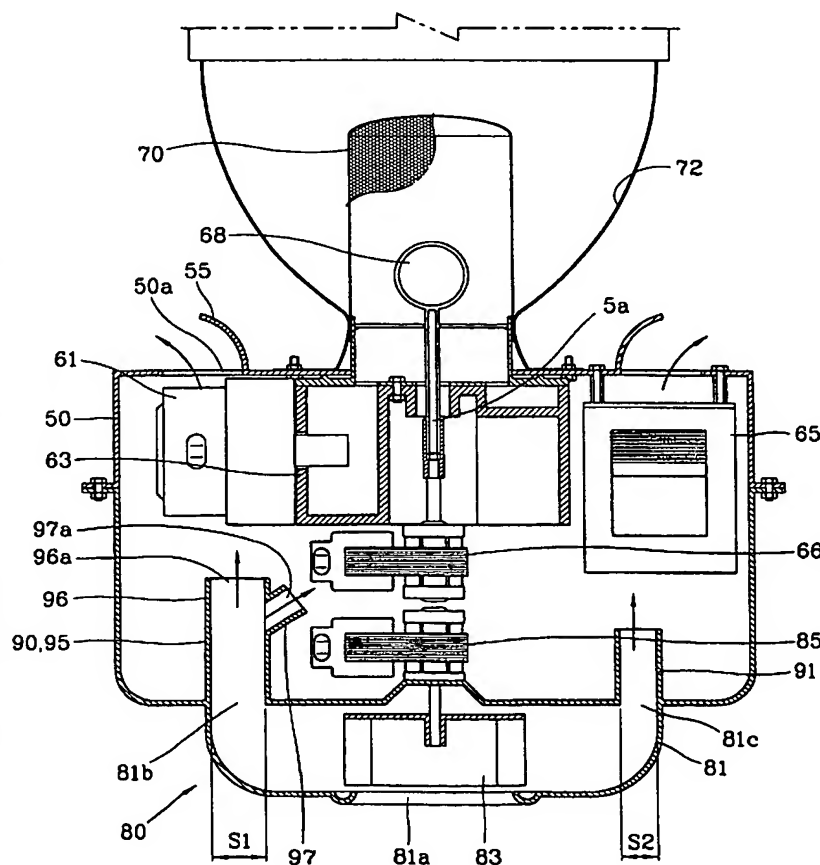
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(54) Title: **COOLING STRUCTURE FOR PLASMA LIGHTING SYSTEM**



(57) Abstract: Disclosed is a cooling structure for a plasma lighting system comprising a fan housing having at least two discharge ports having different flow rates for introducing external air into a case and cooling heat generating components in the case. The structure intensively cools heat generating components of high temperature such as a magnetron, thereby prolonging a life span of the components and enhancing a performance of a system.

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